March 11, 2008

Rambus to Demonstrate High-Speed Memory Technologies and Architectures at DATE 2008

Mar 11, 2008 (BUSINESS WIRE) -- Rambus Inc. (Nasdaq:RMBS):

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Who:       Rambus Inc. (Nasdaq:RMBS)

Where:     DATE 2008
           Booth # A18
           ICM
           Munich, Germany

When:      March 11-13, 2008
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Join Rambus at DATE 2008, the European event for electronic system design and test, for demos and displays of our latest technology developments.

About Rambus Inc.

Rambus is one of the world's premier technology licensing companies specializing in the invention and design of high-speed memory architectures. Since its founding in 1990, the Company's patented innovations, breakthrough technologies and renowned integration expertise have helped industry-leading chip and system companies bring superior products to market. Rambus' technology and products solve customers' most complex chip and system-level interface challenges enabling unprecedented performance in computing, communications and consumer electronics applications. Rambus licenses both its world-class patent portfolio as well as its family of leadership and industry-standard interface products. Headquartered in Los Altos, California, Rambus has regional offices in North Carolina, India, Germany, Japan, Korea and Taiwan. Additional information is available at www.rambus.com.

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Rambus Public Relations
Gabriele Collier, 650-947-5522
gabriele_collier@rambus.com

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